HZ0603B112R-10

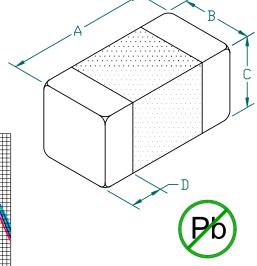
UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

IMPEDANCE (Ω)

IMPEDANCE (Ω)

Α	1.60	[.063]	[±] 0.15	[.006]
В	0.80	[.031]	± 0.15	[.006]
С	0.80	[.031]	± 0.15	[.006]
D	0.36	[014]	± 0.15	[006]



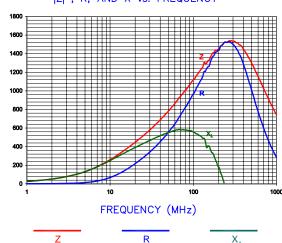
ELECTRICAL CHARACTERISTICS:						
Z @ 100M (Ω)	1Hz	DCR (Ω)	Rated Current			
Nominal	1100					
Minimum	825					
Maximum	1375	0.80	200 mA			

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.

Z vs FREQUENCY
IMPEDANCE UNDER DC BIAS

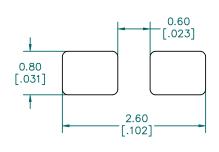
|Z| , R, AND X vs. FREQUENCY



AGILENT E4991A RF Impedance/Material Analyzer

HP 16194A Test Fixture. TEST REF. 3124

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 (.030) to this dimension)

REFLOW SOLDERING 250 PRE-HEATING SOLDERING NATURAL COOLING 130 [266] 100 SECONDS 5 - 10 SECONDS THIS DOCUMENT CONTAINS INSCRIPTION MAICH IS PROPRIETABLY.

RECOMMENDED SOLDERING CONDITIONS

